High Current Transistors

Symbol

VCEO

V_{CBO}

 V_{EBO}

 I_{C}

 P_D

PD

T_J, T_{stg}

Symbol

 $\mathsf{R}_{\theta \mathsf{J}\mathsf{A}}$

 $R_{\theta JC}$

Maximum ratings are those values beyond which device damage can occur.

Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and

Value

-60

-60

-4.0

-1.0

625

5.0

1.5

12

-55 to +150

Max

200

83.3

Unit

Vdc

Vdc

Vdc

Adc

mW

mW/°C

W

mW/°C

°C

Unit

°C/W

°C/W

PNP Silicon

MAXIMUM RATINGS

Collector - Emitter Voltage

Collector Current - Continuous

Collector - Base Voltage

Total Device Dissipation

Derate above 25°C

Total Device Dissipation

Derate above 25°C

Temperature Range

reliability may be affected.

Thermal Resistance,

Thermal Resistance,

Junction-to-Case

Junction-to-Ambient

Operating and Storage Junction

THERMAL CHARACTERISTICS

Characteristic

@ $T_A = 25^{\circ}C$

@ $T_{C} = 25^{\circ}C$

Emitter-Base Voltage

Features

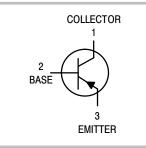
• Pb-Free Package is Available*

Rating



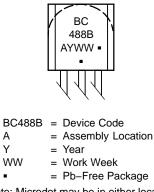
ON Semiconductor®

http://onsemi.com





MARKING DIAGRAM



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BC488BRL1	TO-92	2000/Tape & Reel
BC488BRL1G	TO–92 (Pb–Free)	2000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

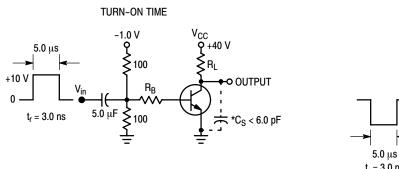
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BC488B

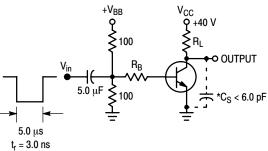
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (Note 1) ($I_C = -10$ mAdc, $I_B = 0$)	V _{(BR)CEO}	-60	-	-	Vdc
Collector – Base Breakdown Voltage ($I_C = -100 \ \mu Adc, I_E = 0$)	V _(BR) CBO	-60	-	-	Vdc
Emitter – Base Breakdown Voltage ($I_E = -10 \ \mu Adc, I_C = 0$)	V _{(BR)EBO}	-4.0	-	-	Vdc
Collector Cutoff Current ($V_{CB} = -40 \text{ Vdc}, I_E = 0$)	I _{CBO}	-	-	-100	nAdc
ON CHARACTERISTICS*					
DC Current Gain $(I_C = -10 \text{ mAdc}, V_{CE} = -2.0 \text{ Vdc})$ $(I_C = -100 \text{ mAdc}, V_{CE} = -2.0 \text{ Vdc})$ $(I_C = -1.0 \text{ Adc}, V_{CE} = -5.0 \text{ Vdc})$	h _{FE}	40 160 15	_ 260 _	_ 400 _	_
Collector – Emitter Saturation Voltage ($I_C = -500 \text{ mAdc}$, $I_B = -50 \text{ mAdc}$) ($I_C = -1.0 \text{ Adc}$, $I_B = -100 \text{ mAdc}$)	V _{CE(sat)}		-0.25 -0.5	-0.5 -	Vdc
Base – Emitter Saturation Voltage $(I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc})$ $(I_C = -1.0 \text{ Adc}, I_B = -100 \text{ mAdc})$	V _{BE(sat)}		-0.9 -1.0	-1.2 -	Vdc
DYNAMIC CHARACTERISTICS					
Current–Gain – Bandwidth Product ($I_C = -50$ mAdc, $V_{CE} = -2.0$ Vdc, f = 100 MHz)	f _T	_	150	_	MHz
Output Capacitance ($V_{CB} = -10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$)	C _{ob}	_	9.0	-	pF
Input Capacitance ($V_{EB} = -0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz}$)	C _{ib}	-	110	-	pF

1. Pulse Test: Pulse Width = $300 \,\mu$ s, Duty Cycle 2%.

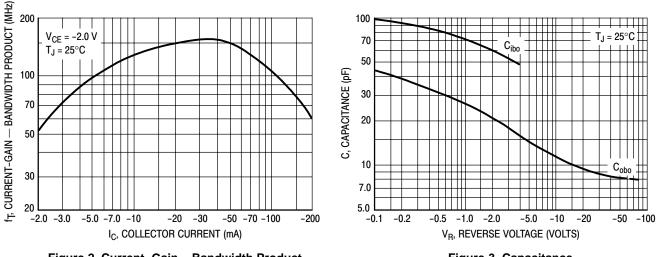


TURN-OFF TIME



*Total Shunt Capacitance of Test Jig and Connectors For PNP Test Circuits, Reverse All Voltage Polarities

Figure 1. Switching Time Test Circuits



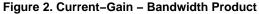
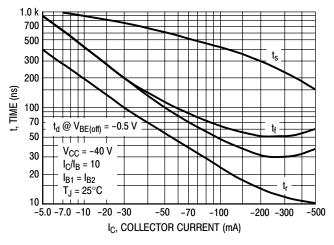


Figure 3. Capacitance





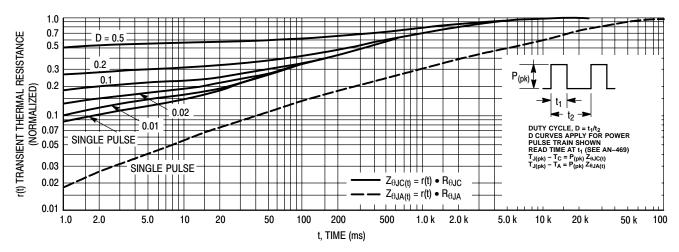


Figure 5. Thermal Response

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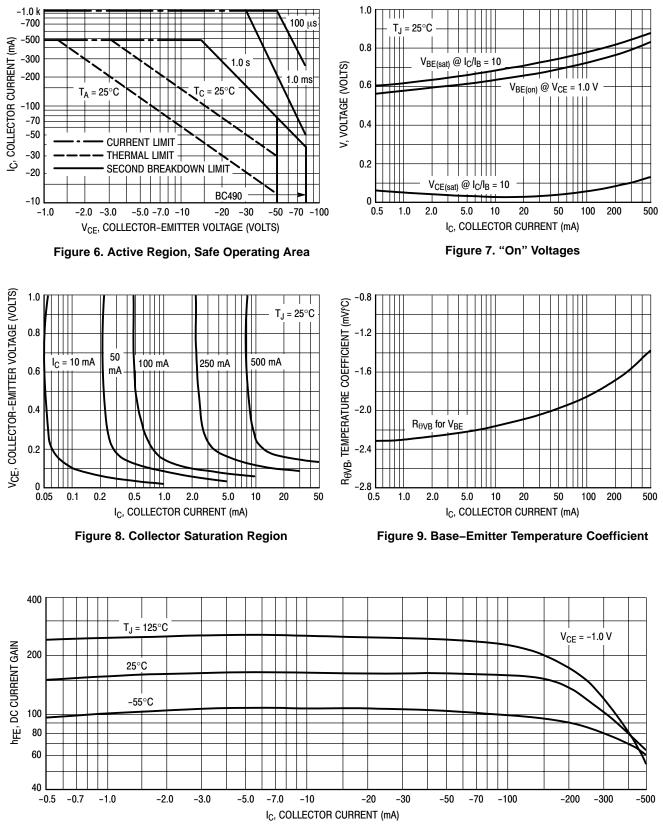


Figure 10. DC Current Gain

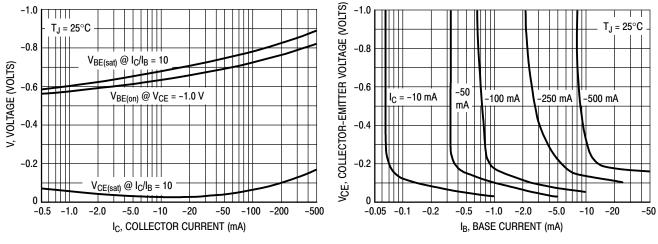




Figure 12. Collector Saturation Region

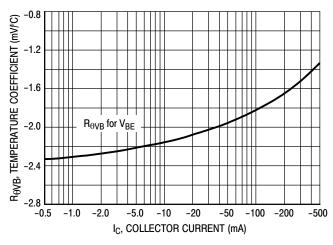
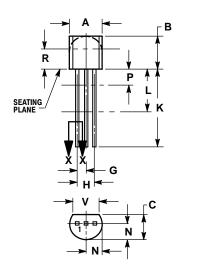


Figure 13. Base–Emitter Temperature Coefficient

BC488B

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





NOTES

DIMENSIONING AND TOLERANCING PER ANSI 1.

Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

3.

CONTIGUEING DIMENSION. INC. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM. 4.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.04	2.66	
Ρ		0.100		2.54	
R	0.115		2.93		
۷	0.135		3.43		

STYLE 17: PIN 1. COLLECTOR BASE

2. 3. EMITTER

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